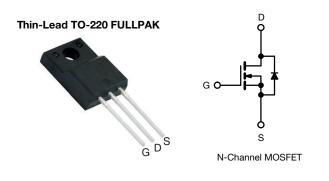
**Vishay Siliconix** 

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## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 2.38				
Q <sub>g</sub> max. (nC)	90				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	19				
Configuration	Single				

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA2N80E-GE3				

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	800	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current (T <sub>.1</sub> = 150 °C) <sup>a</sup>	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I	2.8	
Continuous drain current $(1_j = 150 \text{ C})^{\alpha}$	VGS AL TO V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	1.8	А
Pulsed drain current <sup>b</sup>			I <sub>DM</sub>	5	
Linear derating factor				0.23	W/°C
Single pulse avalanche energy <sup>c</sup>			E <sub>AS</sub>	14	mJ
Maximum power dissipation	PD	29	W		
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	70	1//20
Reverse diode dv/dt <sup>d</sup>				0.13	V/ns
Soldering recommendations (peak temperature) e For 10 s				260	°C
Mounting torque, M3 screw				0.6	Nm

#### Notes

a. Limited by maximum junction temperature

b. Repetitive rating; pulse width limited by maximum junction temperature

c.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 0.9 A

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25 °C

e. 1.6 mm from case

S18-0587-Rev. B, 18-Jun-2018

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9.8

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 $I_D = 1.0 \text{ A}, V_{DS} = 480 \text{ V}$ 

19.6

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nC

DADAMETER	CVMDO!	TVD	MAX.			LINUT	
PARAMETER	SYMBOL	TYP.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	- 65 - 4.3			°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>			0/11			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	unless otherwi	se noted)					
PARAMETER	SYMBOL	TEST CO	ONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V	, I <sub>D</sub> = 250 μA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to	25 °C, I <sub>D</sub> = 1 mA	-	1.0	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		-	4.0	V
Cata aguras laskaga		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	V <sub>GS</sub> :	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
Zere acts welteres dusis summet		$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V, V <sub>G</sub>	<sub>S</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 1.0 A		2.38	2.75	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 1.0 A		-	1.0	-	S
Dynamic				•	•		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	315	-	
Output capacitance	C <sub>oss</sub>			-	20	-	1
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-	1
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	13	-	pF
Effective output capacitance, time	C <sub>o</sub> (tr)			-	45	-	]

Gate-drain charge	Q <sub>gd</sub>		-	3.9	-		
Turn-on delay time	t <sub>d(on)</sub>		-	11	22		
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 1.0 A,	-	7	14	ns	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$	-	19	38		
Fall time	t <sub>f</sub>		-	27	54		
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain	1.8	3.6	7.2	Ω	
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the	-	-	2.8		
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode	-	-	5	A	
Diode forward voltage	V <sub>SD</sub>	$T_{J} = 25 \ ^{\circ}C, I_{S} = 1 \ A, V_{GS} = 0 \ V$	-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>	T 0500 L L 101	-	278	556	ns	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 1.0 A, dI/dt = 100 A/µs, V <sub>B</sub> = 25 V	-	0.9	1.8	μC	
Reverse recovery current	I <sub>RRM</sub>	$a_{\mu}a_{\mu} = 10070 \mu 0, V_{\rm R} = 2000$	-	5	-	А	

 $V_{GS}$  = 10 V

#### Notes

related <sup>b</sup>

Total gate charge

Gate-source charge

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

C<sub>o(tr)</sub>

Qg

Q<sub>gs</sub>

2



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

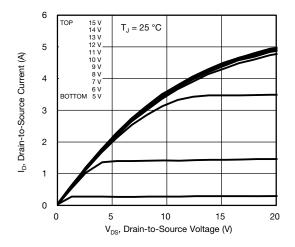
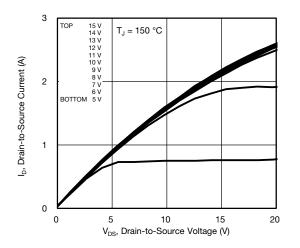
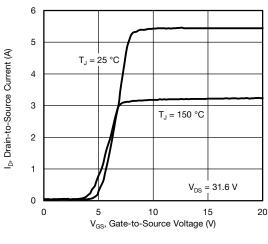


Fig. 1 - Typical Output Characteristics









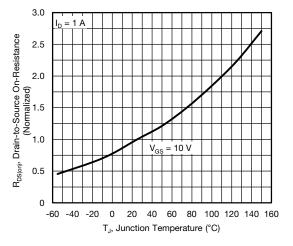


Fig. 4 - Normalized On-Resistance vs. Temperature

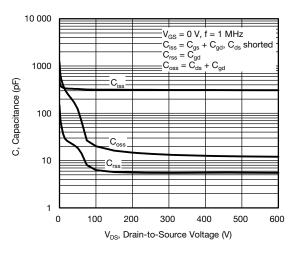


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

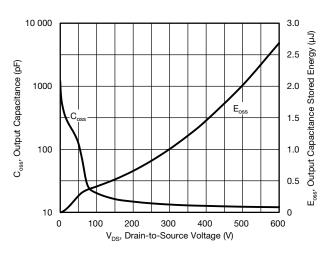


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

S18-0587-Rev. B, 18-Jun-2018

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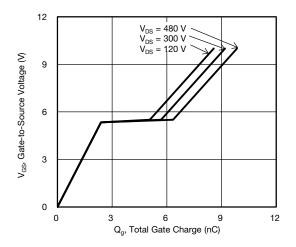


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

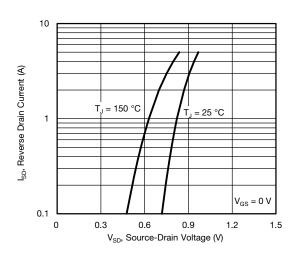


Fig. 8 - Typical Source-Drain Diode Forward Voltage

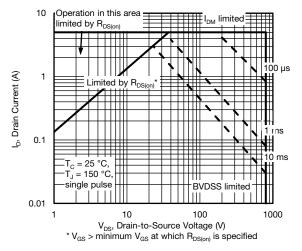


Fig. 9 - Maximum Safe Operating Area

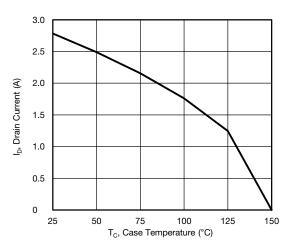


Fig. 10 - Maximum Drain Current vs. Case Temperature

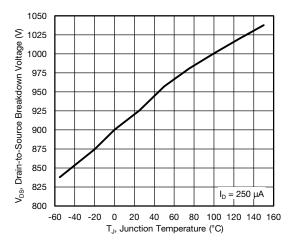


Fig. 11 - Temperature vs. Drain-to-Source Voltage

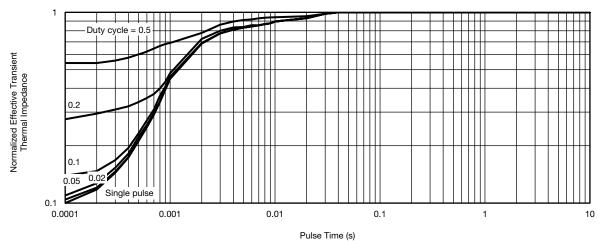
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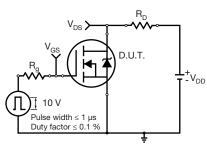


Fig. 13 - Switching Time Test Circuit

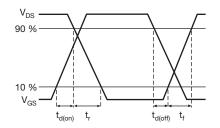


Fig. 14 - Switching Time Waveforms

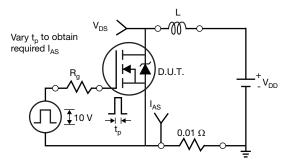


Fig. 15 - Unclamped Inductive Test Circuit

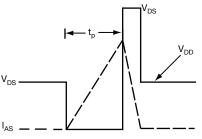


Fig. 16 - Unclamped Inductive Waveforms

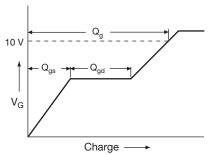


Fig. 17 - Basic Gate Charge Waveform

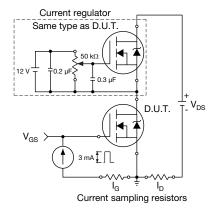


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

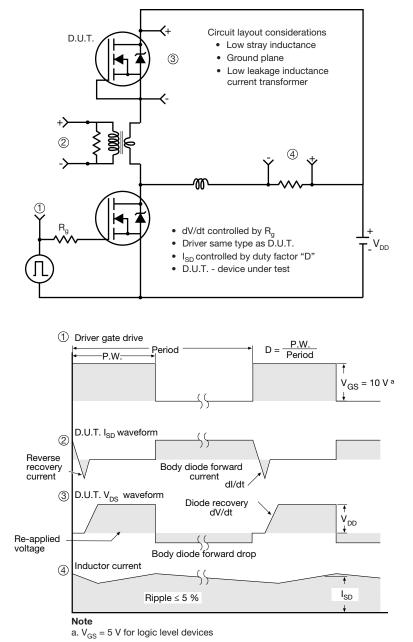


Fig. 19 - For N-Channel

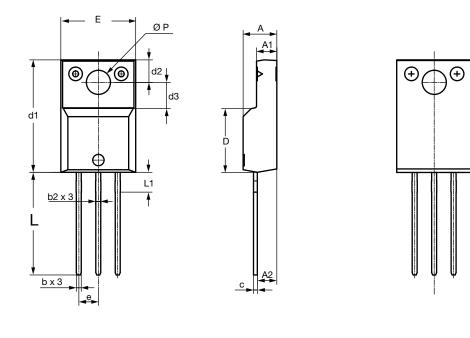
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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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